

250MHz, Rail-to-Rail Output CMOS Operational Amplifier

FEATURES

- HIGH GAIN BANDWIDTH:250MHz
- RAIL-TO-RAIL OUTPUT
- 1.5mV Typical Vos
- INPUT VOLTAGE RANGE: -0.2V to +3.9V with Vs = 5V
- SUPPLY RANGE: +2.5V to +5.5V
- SPECIFIED UP TO +125°C
- Micro SIZE PACKAGES: SOT23-5

APPLICATIONS

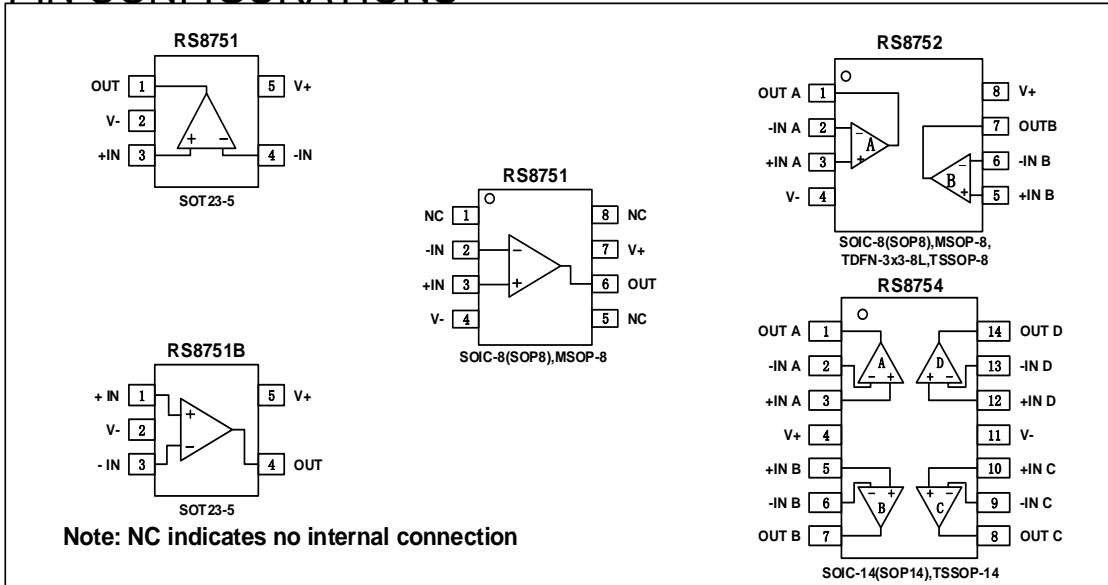
- AUDIO ADC INPUT BUFFERS
- PHOTODIODE PREAMP
- HIGH-DENSITY SYSTEMS
- PORTABLE SYSTEMS
- DRIVING A/D CONVERTERS

DESCRIPTION

The RS875X families of voltage-feedback (VFB) products offer low voltage operation, negative-rail input, rail-to-rail output, as well as excellent speed/power consumption ratio, providing an excellent bandwidth (250MHz) and slew rate of 180V/us. The op-amps are unity gain stable and feature an ultra-low input bias current.

These amplifiers set an industry-leading power-to-performance ratio for rail-to-rail amplifiers. The RS875X families of operational amplifiers are specified at the full temperature range of -40°C to +125°C under single or dual power supplies of 2.5V to 5.5V.

PIN CONFIGURATIONS



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Supply Voltage, V+ to V-.....	7.0V
Input Terminals, Voltage ⁽²⁾	- 0.5 to (V+) + 0.5V
Current ⁽²⁾	±10mA
Storage Temperature	-65°C to +150°C
Operating Temperature	-40°C to +125°C
Junction Temperature.....	150°C
Package Thermal Resistance @ TA = +25°C	
SOT23-5, SOT23-6.....	200°C/W
MSOP-10, SOIC-8 ,TSSOP-8.....	150°C/W
SOIC-14, TSSOP-14.....	100°C/W
Lead Temperature (Soldering, 10s)	260°C
ESD Susceptibility	
HBM	5000V
MM	400V

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING	PACKAGE OPTION
RS8751	RS8751XK	-40°C~125°C	SOIC-8(SOP8)	RS8751	Tape and Reel,2500
	RS8751XF	-40°C~125°C	SOT23-5	8751	Tape and Reel,3000
	RS8751BXF	-40°C~125°C	SOT23-5	8751B	Tape and Reel,3000
	RS8751XM	-40°C~125°C	MSOP-8	RS8751	Tape and Reel,3000
RS8752	RS8752XK	-40°C~125°C	SOIC-8(SOP8)	RS8752	Tape and Reel,2500
	RS8752XM	-40°C~125°C	MSOP-8	RS8752	Tape and Reel,3000
	RS8752XTDC8	-40°C~125°C	TDFN-3x3-8L	RS8752	Tape and Reel,3000
	RS8752XQ	-40°C~125°C	TSSOP-8	RS8752	Tape and Reel,3000
RS8754	RS8754XP	-40°C~125°C	SOIC-14(SOP14)	RS8754	Tape and Reel,2500
	RS8754XQ	-40°C~125°C	TSSOP-14	RS8754	Tape and Reel,3000

ELECTRICAL CHARACTERISTICS

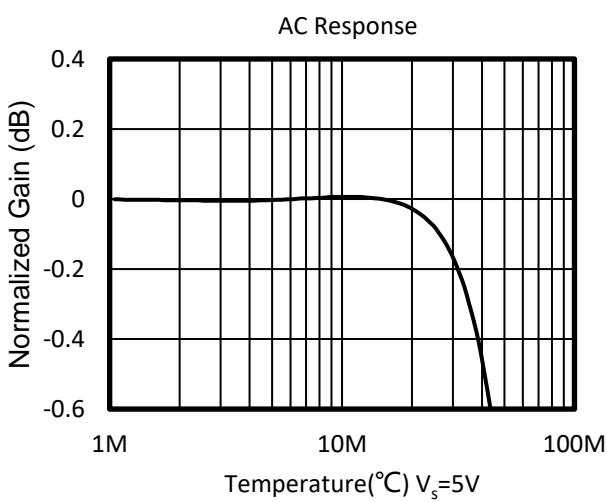
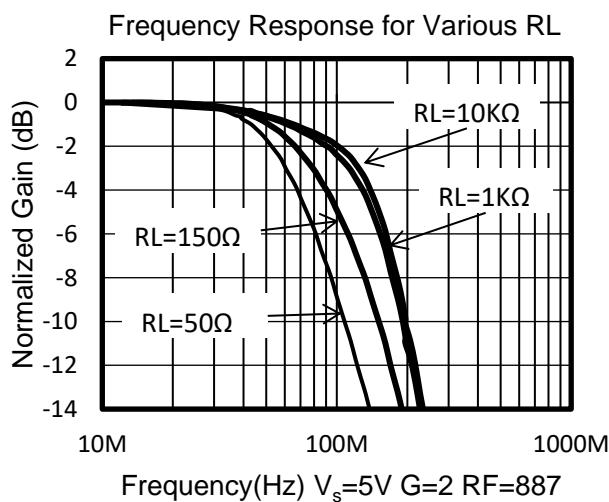
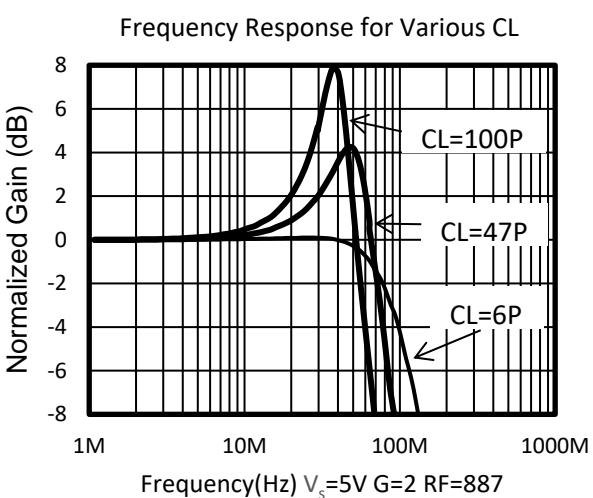
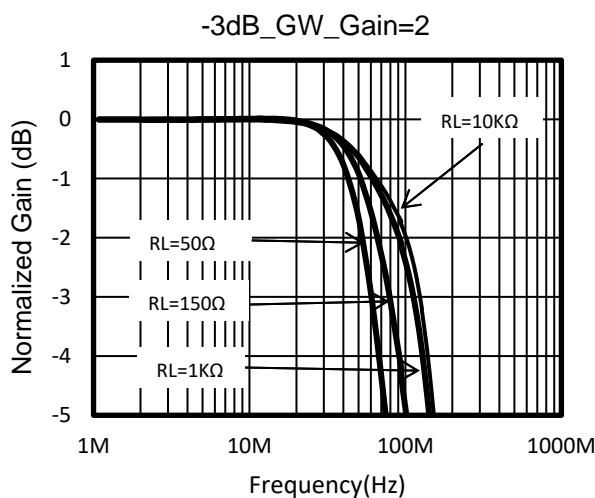
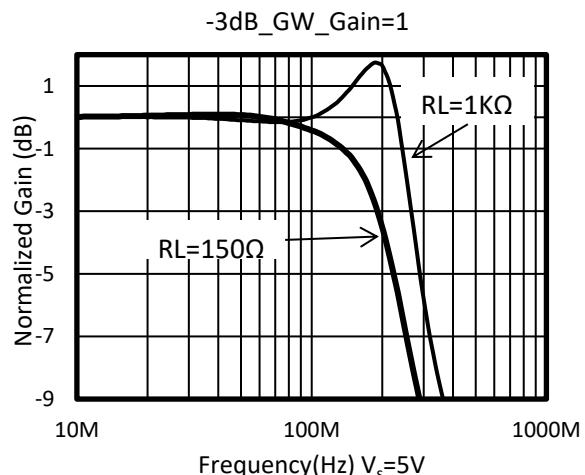
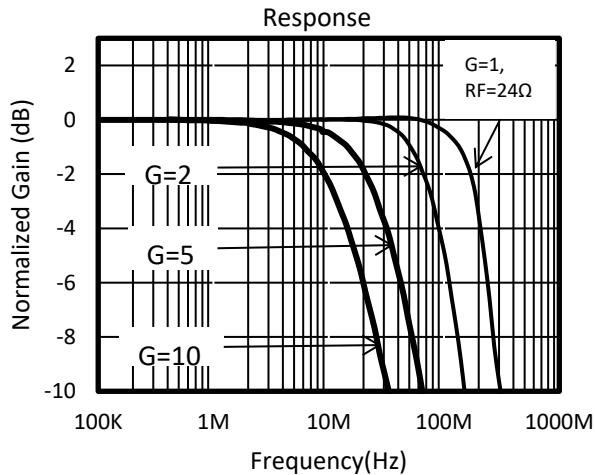
(At TA = +25°C, VS = 5V, G = +2, RF = 1K Ω, and RL = 1KΩ connected to VS/2, V_{IN_CM} =Vs/2, unless otherwise noted.)

PARAMETER	CONDITIONS	RS8751,RS8752,RS8754				UNITS
		MIN	TYP	MAX		
POWER SUPPLY						
V _s	Operating Voltage Range		2.5		5.5	V
I _Q	Quiescent Current/Amplifier			2.9	3.5	mA
PSRR	Power-Supply Rejection Ratio	V _s =2.5V to 5.5V, V _{cm} =(V ₋)+0.5V	70	90		dB
INPUT						
V _{os}	Input Offset Voltage	V _{cm} =V _s /2		±1.5	±7.5	mV
ΔV _{os} /ΔT	Input Offset Voltage Drift	V _{cm} =V _s /2, -40°C ≤ TA ≤125°C		4		μV/°C
I _B	Input Bias Current			1	10	pA
I _{os}	Input Offset Current			1	10	pA
V _{cm}	Common-Mode Voltage Range	V _s = 5V	-0.2		3.9	V
CMRR	Common-Mode Rejection Ratio	V _s = 5.5V, V _{cm} =-0.2V to 3.5V	66	85		dB
OUTPUT						
AOL	Open-Loop Voltage Gain	V _s =5.0V, R _L =1KΩ, V _o =V _s -0.2V	95	110		dB
		V _s =5.0V, R _L =150Ω, V _o =V _s -0.3V	78	85		dB
	Output Swing From Rail	R _L =1KΩ		23		mV
I _{out}	Output Current Source			85		mA
I _{out}	Output Current Sink			125		mA
FREQUENCY RESPONSE						
	Small-Signal Bandwidth	V _{OUT} =100mVpp,G=1		250		MHz
		V _{OUT} =100mVpp,G=2		130		MHz
		V _{OUT} =100mVpp,G=5		33		MHz
		V _{OUT} =100mVpp,G=10		15		MHz
SR	Slew Rate			180		V/us
GBP	Gain-Bandwidth Product			250		MHz
PM	Phase Margin			62		°
NOISE						
e _n p-p	Input Voltage Noise	f = 0.1 Hz to 10 Hz		13		μVpp
e _n	Input Voltage Noise Density	f = 1 MHz		8		nV/√Hz

TYPICAL CHARACTERISTICS

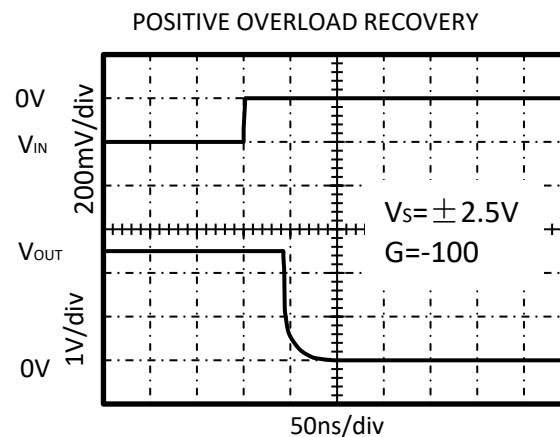
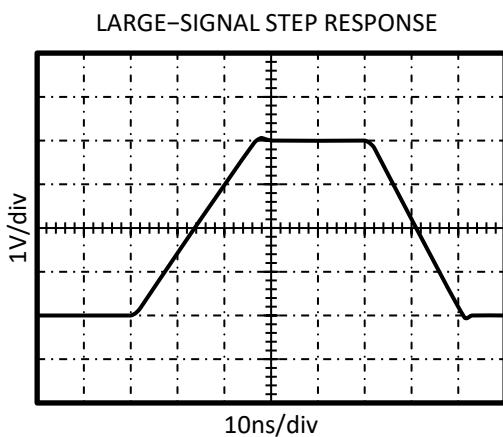
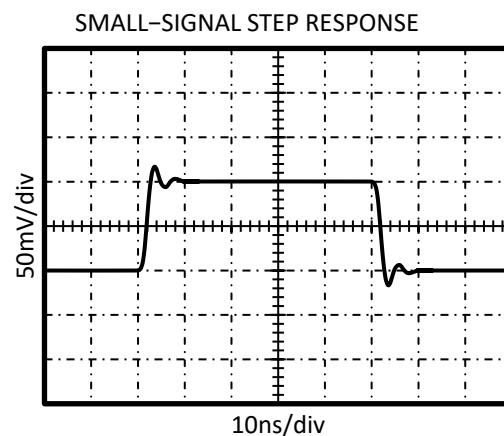
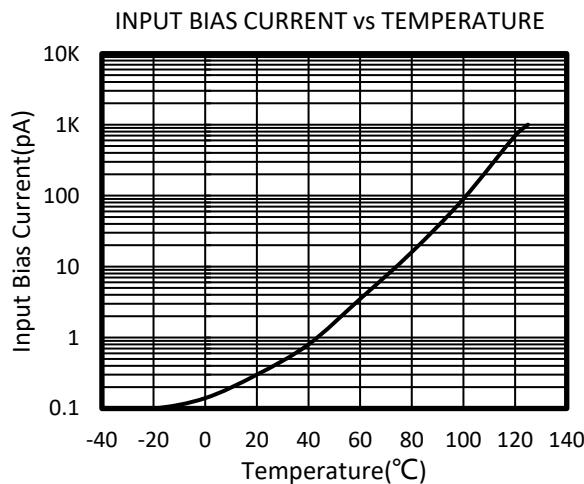
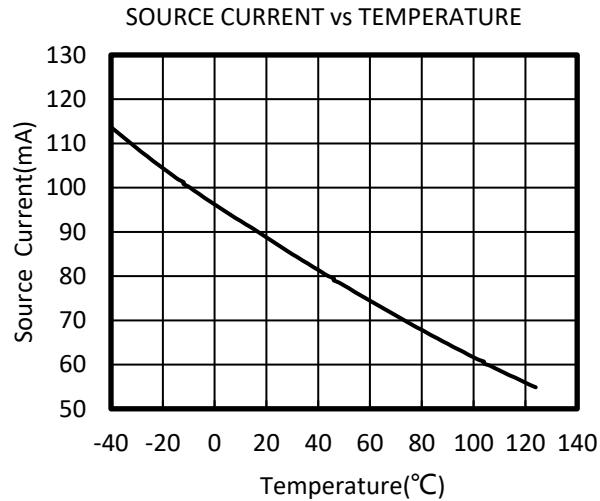
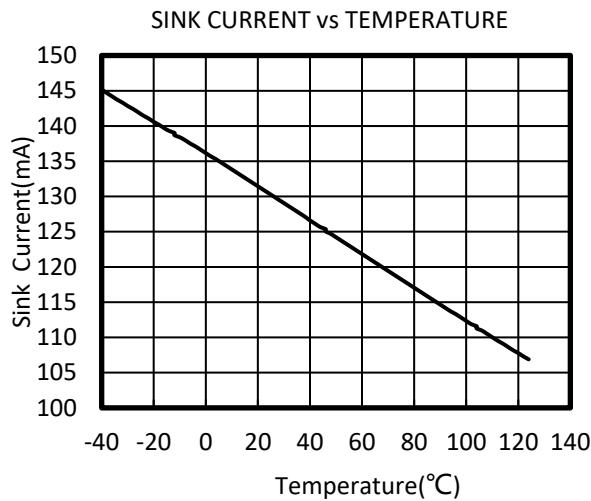
At TA = +25°C, VS = 5V, G = +2, RF = 1K Ω, and RL = 1KΩ connected to VS/2, V_{IN_CM} =Vs/2, unless otherwise noted

Non-Inverting Small-Signal Frequency Response



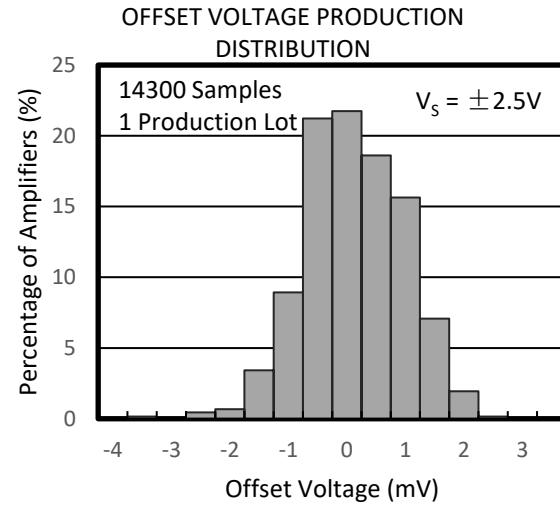
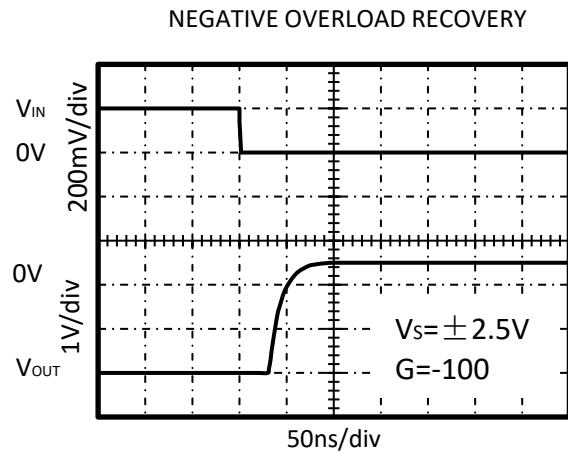
TYPICAL CHARACTERISTICS

At TA = +25°C, VS = 5V, G = +2, RF = 1K Ω, and RL = 1KΩ connected to VS/2, V_{IN_CM} =Vs/2, unless otherwise noted



TYPICAL CHARACTERISTICS

At $TA = +25^\circ\text{C}$, $VS = 5\text{V}$, $G = +2$, $RF = 1\text{K}\Omega$, and $RL = 1\text{K}\Omega$ connected to $VS/2$, $V_{IN_CM} = VS/2$, unless otherwise noted



APPLICATION NOTES

The RS8751, RS8752, RS8754 are high precision, rail-to-rail operational amplifiers that can be run from a single-supply voltage 2.5V to 5.5V ($\pm 1.25V$ to $\pm 2.75V$). Supply voltages higher than 7V (absolute maximum) can permanently damage the amplifier.

Rail-to-rail input and output swing significantly increases dynamic range, especially in low-supply applications.

Good layout practice mandates use of a 0.1 μ F capacitor place closely across the supply pins.

LAYOUT GUIDELINES

Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1 μ F capacitor closely across the supply pins.

These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI susceptibility.

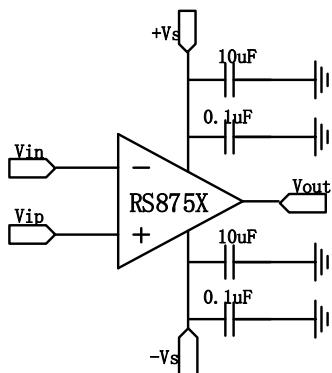


Figure1. Amplifier with Bypass Capacitors

INSTRUMENTATION AMPLIFIER

In the three-op amp, instrumentation amplifier configuration shown in Figure2,

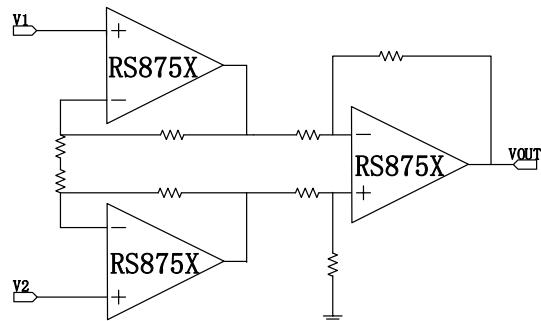
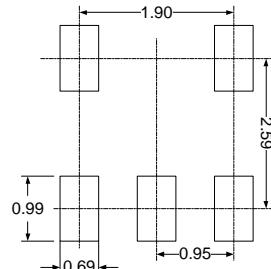
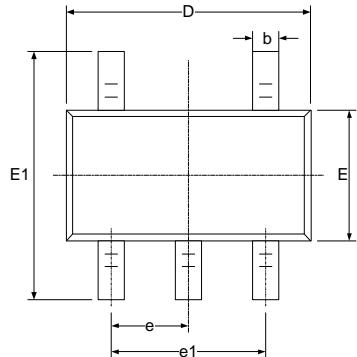
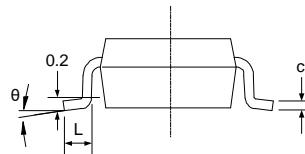
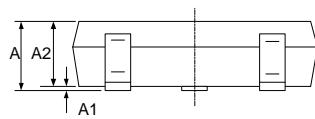


Figure2. Amplifier instrumentation amplifier

PACKAGE OUTLINE DIMENSIONS SOT23-5

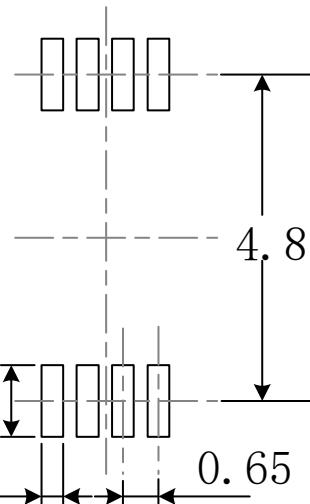
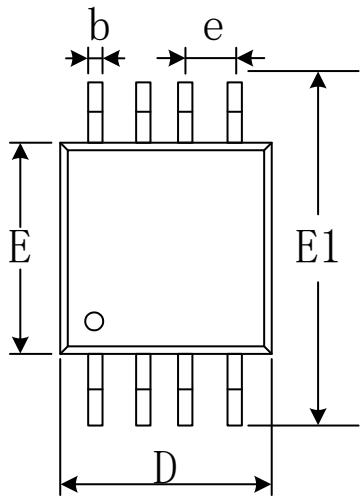


RECOMMENDED LAND PATTERN (Unit: mm)

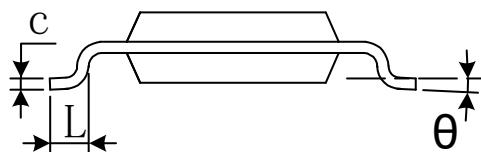
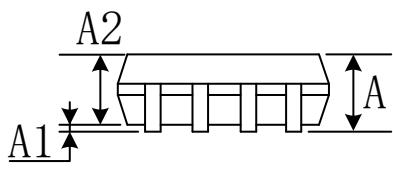


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

MSOP-8

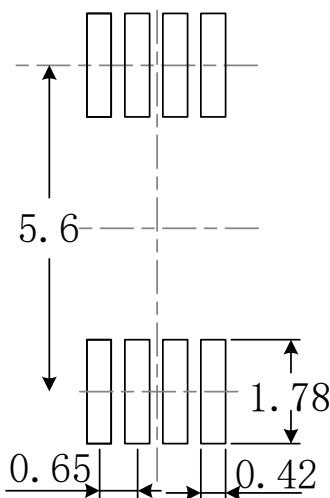
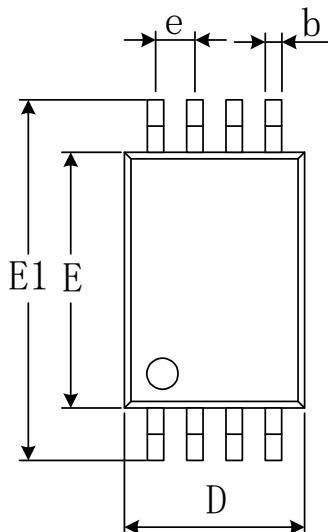


RECOMMENDED LAND PATTERN (Unit: mm)

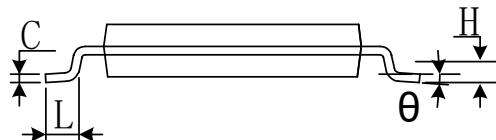
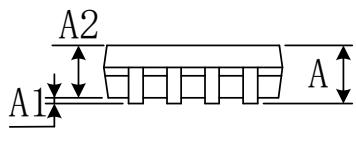


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.650(BSC)		0.026(BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

TSSOP-8

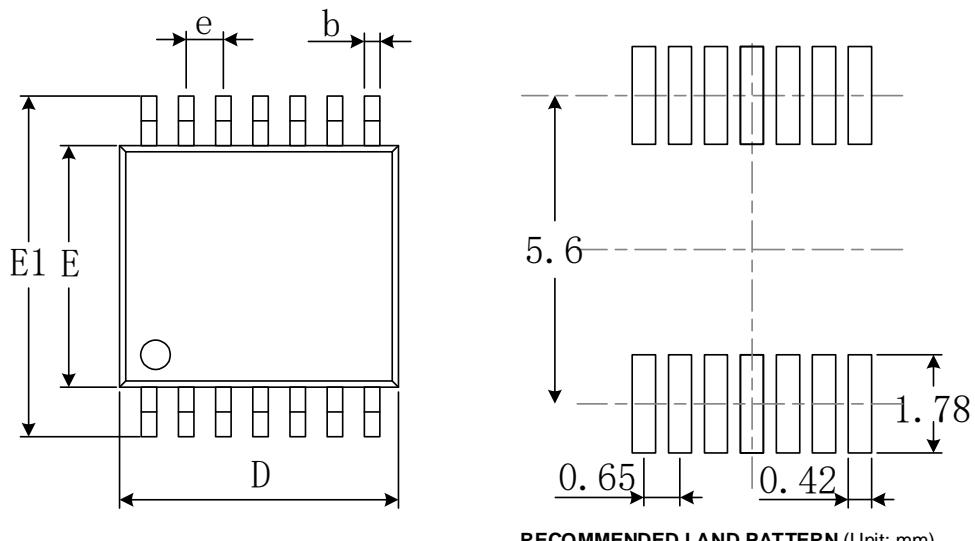


RECOMMENDED LAND PATTERN (Unit: mm)

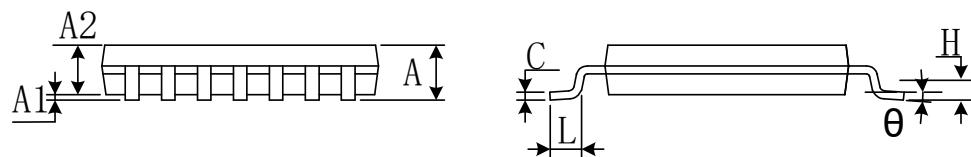


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	2.900	3.100	0.114	0.122
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650(BSC)		0.026(BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

TSSOP-14

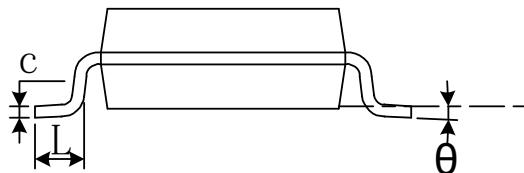
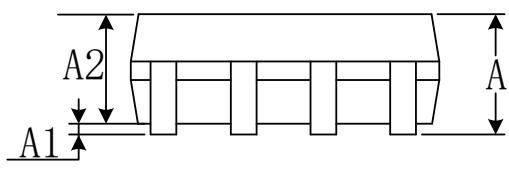
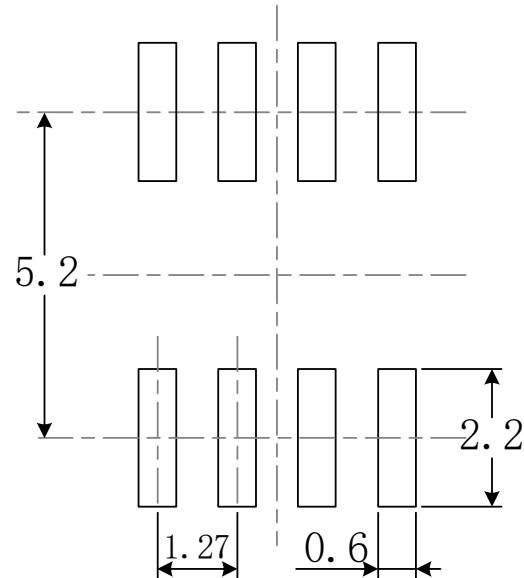
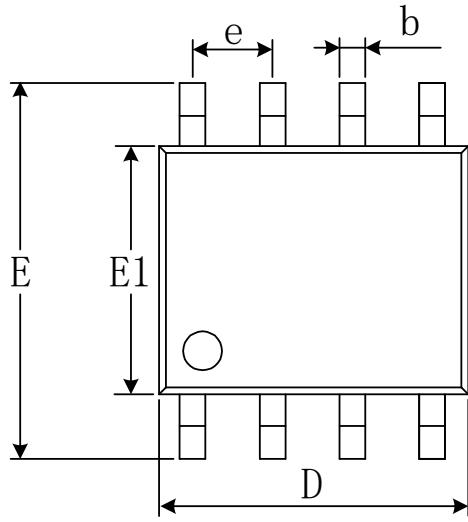


RECOMMENDED LAND PATTERN (Unit: mm)



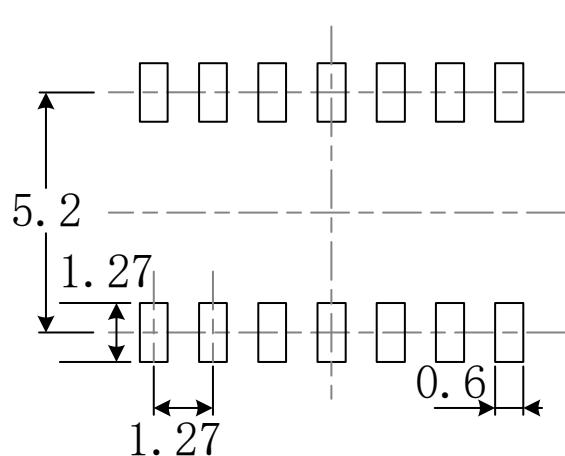
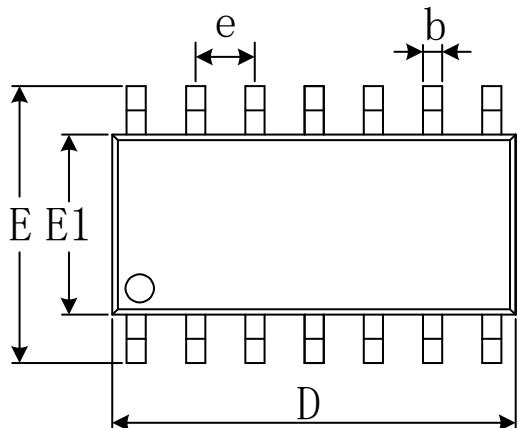
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	Min	Max	Min	Max
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.860	5.100	0.191	0.201
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650(BSC)		0.026(BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

SOIC-8(SOP8)

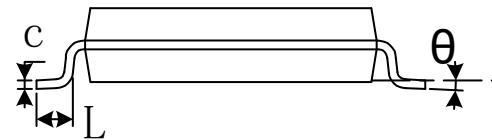
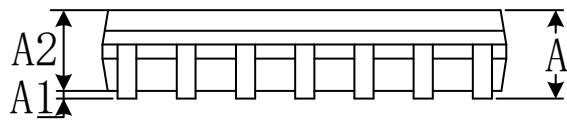


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

SOIC-14(SOP14)

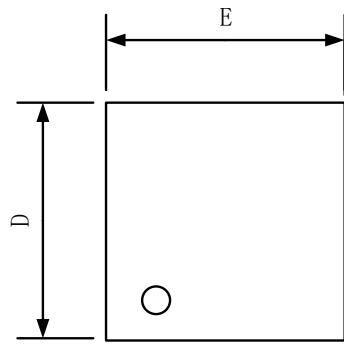


RECOMMENDED LAND PATTERN (Unit: mm)

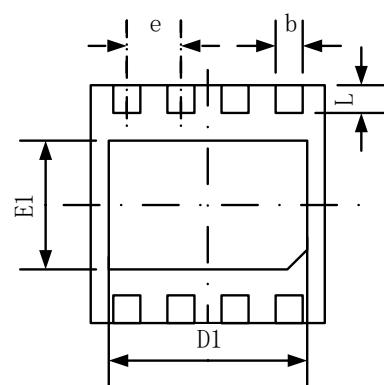


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.310	0.510	0.012	0.020
c	0.100	0.250	0.004	0.010
D	8.450	8.850	0.333	0.348
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

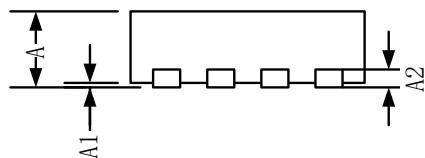
TDFN-3x3-8L



TOP VIEW



BOTTOM VIEW



SIDE VIEW

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203		0.008	
b	0.300	0.400	0.012	0.016
D	2.900	3.100	0.114	0.122
D1	2.510	2.610	0.099	0.103
E	2.900	3.100	0.114	0.122
E1	1.550	1.650	0.061	0.065
e	0.650 TYP		0.026 TYP	
L	0.350	0.450	0.014	0.018